High Power Resistive Products

Terminations

AVX introduces its complete line of High Power Termination Products. All Products are designed and manufactured at our ISO 9001 Facilities. All products are qualified as per MIL-PRF-55342.

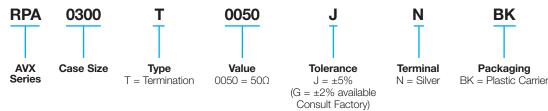
ELECTRICAL SPECIFICATIONS

Resistance: 50 Ω standard (10 Ω - 200 Ω available) Resistance Tolerance: ±5% standard (±2% available) Power: 2 Watts through 225 Watts Operating Temperature Range: -55°C to +150°C Temperature Coefficient: < 150 ppm/°C Low VSWR

MECHANICAL SPECIFICATIONS

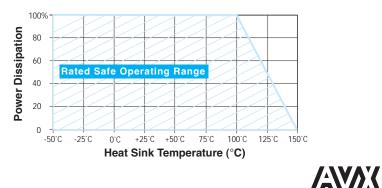
Package: Surface Mount Chips, Chips, Leaded Chips, Flange Mount Substrate Material: Aluminum Nitride Process: Thin Film Resistive Material: Tantalum Terminals: Silver Cover: Alumina Mounting Flange: 100% Cu, Ni or Ag Plated Mechanical Tolerance: ±0.13 (0.005) **RoHS Compliant** SMT and Chip products, supplied on Tape and Reel

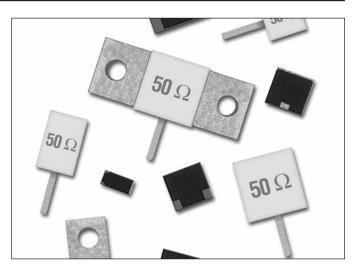
FLANGE MOUNT TERMINATIONS **HOW TO ORDER**



Contact factory for custom ratings and sizes.

POWER DERATING







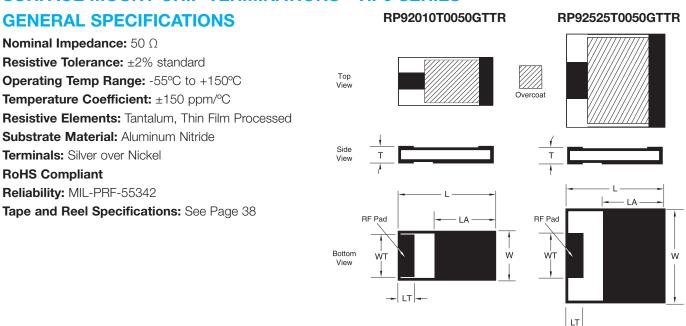


High Power Resistive Products



Terminations

SURFACE MOUNT CHIP TERMINATIONS – RP9 SERIES



mm (inches)

AVX Part Number	W ±0.25 (0.010)	L ±0.25 (0.010)	T ±0.13 (0.005)	LT ±0.13 (0.005)	WT ±0.13 (0.005)	LA ±0.13 (0.005)	Frequency Range (GHz)	VSWR (Typ.)	Power Max** (Watts)
RP92010T0050GTTR	2.54 (0.100)	5.08 (0.200)	1.02 (0.040)	1.02 (0.040)	2.29 (0.090)	2.92 (0.115)	DC - 3.0	1.20:1	10W
RP92525T0050GTTR	6.22 (0.245)	6.22 (0.245)	1.02 (0.040)	0.76 (0.030)	3.18 (0.125)	4.32 (0.170)	DC - 4.0	1.25:1	20W

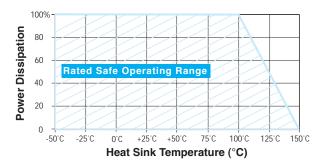
** Test Condition: Chip soldered to a via patch on a 30-mil-thick Rogers RO4350 board; Land surfaces at 100°C; maximum rated power applied. Specification: The resistance of the film shall change no more than 0.5% during and after a 1000-hr. Burn-in per Mil-PRF-55342.

HOW TO ORDER



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POWER DERATING

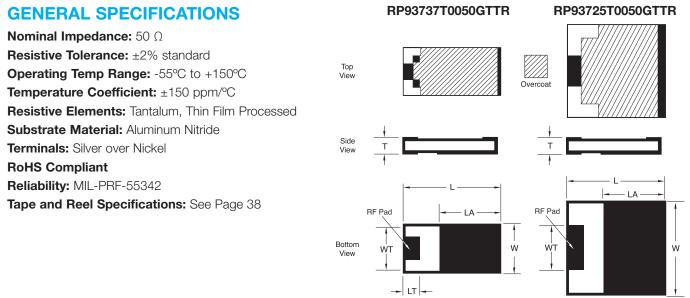


High Power Resistive Products



Terminations

SURFACE MOUNT CHIP TERMINATIONS – RP9 SERIES



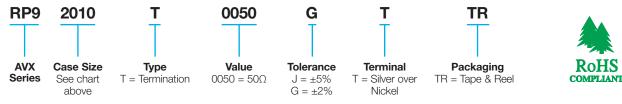
mm (inches)

LT

AVX Part Number	W ±0.25 (0.010)	L ±0.25 (0.010)	T ±0.13 (0.005)	LT ±0.13 (0.005)	WT ±0.13 (0.005)	LA ±0.13 (0.005)	Frequency Range (GHz)	VSWR (Typ.)	Power Max** (Watts)
RP93725T0050GTTR	6.35 (0.250)	9.53 (0.375)	1.02 (0.040)	1.27 (0.050)	3.18 (0.125)	6.60 (0.260)	DC - 2.2	1.20:1	30W
RP93737T0050GTTR	9.40 (0.370)	9.40 (0.370)	1.02 (0.040)	1.27 (0.050)	3.18 (0.125)	6.99 (0.275)	DC - 3.0	1.25:1	40W

** Test Condition: Chip soldered to a via patch on a 30-mil-thick Rogers RO4350 board; Land surfaces at 100°C; maximum rated power applied. Specification: The resistance of the film shall change no more than 0.5% during and after a 1000-hr. Burn-in per Mil-PRF-55342.

HOW TO ORDER



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POWER DERATING

